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DEK NeoHorizon 03iX More reliability & efficiency for future-proof printing

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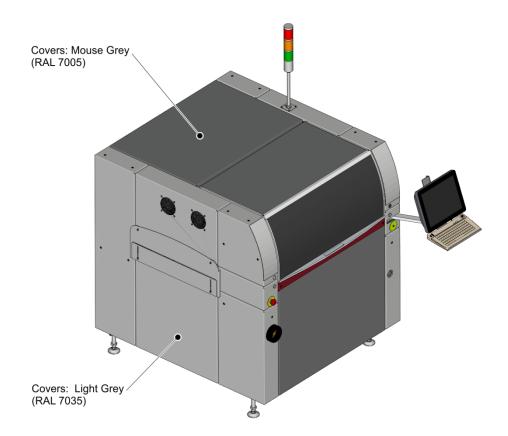
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Overview of technical data

Maximum values

Machine Alignment Capability	> 2.0 C _{mk} @ +/- 12.5µm, (±6 Sigma)
System Alignment Capability	> 2.0 C _{mk} @ +/- 20μm, (±6 Sigma)
Wet Print Capability	> 2.0 C _{pk} @ +/- 25µm, (±6 Sigma)
Core Cycle Time	8 secs + process
Operating System	Windows 7 Standard embedded
Squeegee Pressure Mechanism	Software controlled, motorised with closed loop feedback
Under Stencil Cleaning	Interchangeable Under Stencil (IUSC) cleaner, fully programmable with wet/dry/vacuum wipe with external solvent tank.

Machine colours for DEK NeoHorizon 03iX



Machine description

DEK NeoHorizon iX platform – More reliability and efficiency for future-proof printing

The DEK NeoHorizon iX shines with more than new design. It's modular interior is much improved and highly reliable. Whether in high-mix contract manufacturing or high-volume applications with high throughput requirements – the DEK NeoHorizon iX is the right printing platform.

Benchmark for accuracy

The DEK NeoHorizon iX platform is based on an exceptionally stable frame design. With its torsional rigidity and high intrinsic resonance frequency, the machine's frame provides the foundation for longevity and long-lasting accuracy. With its advanced controllers and bus systems, the DEK NeoHorizon 03iX achieves a system alignment capability of ±20µm @ 2 Cmk (6 Sigma).

The frame provides lots of space and the bus system a wide range of interfaces for basic components like precision drives, digital camera modules and high precision guides and slides, as well as for many productivity-enhancing options: the DEK Productivity Tools.

State-of-the-art software: DEK Instinctiv

With its touchscreen, keyboard and trackball operation, graphical interfaces, multiple languages and integrated video-based help, the DEK Instinctiv software supports the easy, quick and error-free operation of the NeoHorizon iX printer.

With ISCAN (Intelligent Scalable Area Network), the new configuration can be scanned with just a few clicks and additional performance is available. And thanks to its interfaces, the DEK NeoHorizon can fine-tune its printing process based on data imported from modern SPI systems.

The right configuration for every job

High-speed production, high-mix runs of small lots, pin-in-paste, ultrafine apertures for supersmall components, stepped stencils, PCBs with unusual substrates, many different paste types – no matter what the production requirements are and what processes are being used: the DEK NeoHorizon iX platform always accommodates the right configuration for the printing process.

B2B setup: Flexible on two tracks

The DEK NeoHorizon Back-to-Back setup makes for a uniquely flexible dual-track solution. Both units remain separately controllable, can be split up again at any time and use the full-size printing area.

Faster cleaning, more throughput

The DEK NeoHorizon 03iX offers two models of automatic understencil cleaning: the new IUSC as standard or the awardwinning and much improved DEK Cyclone high-speed cleaning system as an option.

Standard Configuration	Specification
Machine Alignment Capability	> 2.0 C _{mk} @ +/- 12.5μm, (±6 Sigma)
System Alignment Capability	> 2.0 C _{mk} @ +/- 20µm, (±6 Sigma)
Wet Print Capability	> 2.0 C _{pk} @ +/- 25µm, (±6 Sigma)
Core Cycle Time	8 secs + process
Maximum Print Area	510mm* (X) x 508.5mm (Y)
Printer Construction	One piece optimised welded frame
ISCAN TM Machine Control	Motion control using CAN BUS network
Operating System	Windows 7 Standard embedded
Operator Interface	Colour TFT touch screen display, keyboard and trackball with DEK Instinctiv [™] software. Machine mountable on either left or right hand side.
Camera	HawkEye® 750 digital camera, using IEEE 1394 interface. Multi channel. LED lighting. FOV 11.3mm x 8.7mm. Inspection window 26mm ²
Camera Positioning	Rotary motors and encoders with 4 micron resolution
Squeegee Pressure Mechanism	Software controlled, motorised with closed loop feedback
Stencil Positioning	Semi-Auto-Load incorporating squeegee drip tray
Stencil Alignment	Motorised via actuators X, Y, and Theta
Under Stencil Cleaning	Interchangeable Under Stencil (IUSC) cleaner, fully programmable with wet/dry/vacuum wipe with external solvent tank. Specify length (300mm, 400mm, 520mm)
Vacuum Assist for Under Stencil Cleaning	On board vacuum unit 25 litres/sec airflow
Squeegee	Clamped double trailing edge squeegee (1 set included)
Machine Interface	Upline and downline FMI included
Connectivity	RJ-45LAN (networking) and USB2/3 interface available
Tri Colour Beacon	Programmable with audible alarm
Documentation	Hard copy manuals comprising: Operator, Installation, Electrical Drawings. On board technical manuals and tutorials supporting operator functions. DVD containing manuals and tutorials.

^{*} For print area up to 600mm long please contact the Product Manager

Transport System	Specification
Туре	Single piece with 3mm round transport belts, front rail fixed
ESD Compatibility	Transport belts and guides with surface resistivity between 10 ⁶ and 10 ¹¹ ohms
Width Adjustment	Programmable motorized rear rail
Transport Direction	Left to right Right to left Left to left Right to right
Substrate Handling Size (minimum)	50mm (X) x 40.5mm (Y)
Substrate Handling Size (maximum)	510mm (X) x 508.5mm (Y)
Substrate Thickness	0.2mm to 6mm
Substrate Weight (maximum)	1kg
Substrate Warpage	Up to 7mm including substrate thickness
Substrate Fixture	Over the top clamps
Substrate Handling Features	Soft rail lift/land Board clamp regulator
Substrate Underside Clearance	Programmable 3mm to 42mm

Process Parameter	Specification
Print Pressure	0kg to 20kg
Print Speed	2mm/sec to 300mm/sec
Print Gap	0mm to 6mm
Substrate Separation	Speed: 0.1mm/sec to 20mm/sec
	Distance: 0mm to 20mm
Print Modes	ProFlow®
	Print/Print
	Print/Flood
	Flood/Print
	Adhesive
Paste Knead	Programmable: number; period; on demand

Vision	Specification
Vision System	Cognex
Fiducial Recognition	Automatic fiducial teach and find incorporating 0.1mm fiducial capture
Fiducials	2 or 3
Fiducial Types	Synthetic fiducial library or unique pattern recognition
Fiducial Size	0.1mm to 3mm
Fiducial Locations	Anywhere on substrate
Fiducial Error Recovery	Auto lighting adjustment
	Auto fiducial search
Camera Lighting	Software controlled programmable LED lighting

Standard C Chase	Specification	
Screen Frame Size (maximum)	736mm x 736mm (29" x 29")	
Screen Frame Thickness	25mm to 38mm (1" to 1.5")	
Image Position	Front Centre Custom	

Operating Environment	Specification
Temperature	10° to 35°C (50° to 95°F)
Humidity	30% to 70% relative humidity (non-condensing)

Services	Specification
Voltage	100 Volts to 240 Volts ±10%. Single phase 50/60 Hz
Maximum Current at 115V	20 Amps with vacuum pump 6 Amps without vacuum pump
Maximum Current at 230V	10 Amps with vacuum pump 3 Amps without vacuum pump
Over Current Protection	An external circuit breaker ≤25 Amps is required to be fitted in line with the machine supply
Air Supply	To ISO 8573.1 Standard Quality Class 2.3.3 Pressure 5 bar to 8 bar General usage 5 litres/minute at 5 bar to 8 bar Maximum usage 226 litres/minute at 6 bar

Shipping Information	Specification
Approximate Weight	850kg boxed (dependent upon configured options selected with machine) 690kg unboxed (dependent upon configured options selected with machine)
Approximate Dimensions	2080mm x 1500mm x 1590mm High (81.9" x 59" x 62.6") Boxed

Certification	Specification	
CE	98/37/EC	
	89/336/EEC	
	73/23/EEC	
	Subsequent amendments	
Acoustic Noise Level	Less than 70dB 2003/1/EC	

DEK NeoHorizon 03iX Machine productivity options

Process	Specification
Print Method	Paste Dispenser Paste Roll Height Monitor (aPRHM) ProFlow® ATx Stinger
Printing Environment Control	Contact PM
Recommended Stencil Frame	VectorGuard
Adjustable Width Stencil Mount (AWSM)	Frame variants – Fully adjustable to accommodate frame sizes in the range of 381mm to 736mm (15" to 29") by 38mm height. Image position: Centre/Front/Custom
Under Stencil Cleaning	Cyclone high speed cleaner, fully programmable with wet/dry/vacuum wipe with external solvent tank
	Cyclone Duo. Specify length (300mm, 400mm, 460mm, 515mm)
Vacuum Assist for Under Stencil Cleaning	On board vacuum unit 35 litres/second airflow On board venturi vacuum unit
Stencil Positioning	Automatic loading incorporating squeegee drip tray
Temperature/Humidity Sensor	Monitoring of the process environment

Handling & Cleaner Options	Specification
Substrate Handling Size (maximum)	620mm (X) x 508.5mm (Y) – Long Board Option
Under Stencil Cleaning	Blue large board cleaner (580mm)

Software & Communications	Specification
Substrate Handling	Flexible boards Selective print pass through Singulation
Software & Communications	GEM on TCP/IP
Statistical Process Control	On board, reported via operator interface (QC-CALC)

DEK NeoHorizon 03iXMachine productivity options

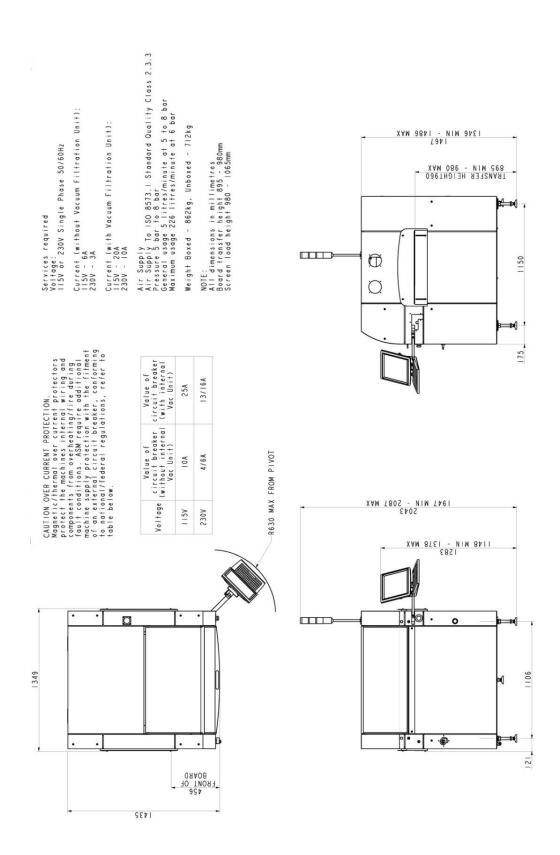
Transport	Specification
Substrate Support	Vacuum tooling capability Vacuum tooling sensor Vacuum cupes Grid-Lok® tooling
Substrate Transport	Single piece conveyor with flat belts (heavy boards) Remote board stop (for use with heavy board option) Dual Speed Motor* (to be released)
Substrate Fixture	All Purpose Clamping (APC) system* Snuggers (edge clamping) Foil-less clamps

^{*} Can only be used with Modular rail system

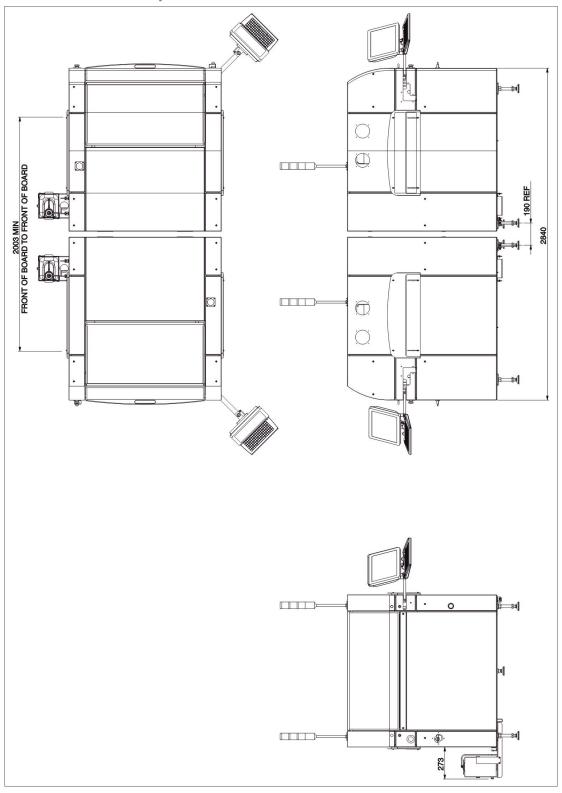
Vision & Verfication	Specification
HawkEye® 750 Paste on Pad Verification	Enabled
HawkEye® 1700 Paste on Pad Verification	Enabled (camera included)
HawkEye	HawkEye® Bridging (requires HawkEye® 1700 camera)
2Di Inspection	Basic stencil and board Advanced stencil and board

Data Capture	Specification
Product Data Capture	Verification & Traceability ProDEK closed loop

Machine footprint



Machine footprint Back to Back



Notes

Notes

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In line with ASMAS Group Policy of continual improvement, this specification is periodically upissued to reflect the latest product enhancements and it is provided with an issue state, which is displayed at the bottom of the rear page.

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